## Part Number: XZFBB81FS

2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

#### **Features**

• Ideal for indication light on hand held products

• Long life and robust package

• Variety of lens types and color choices available

ullet Package : 2000pcs / reel

• Moisture sensitivity level : level 3

• RoHS compliant

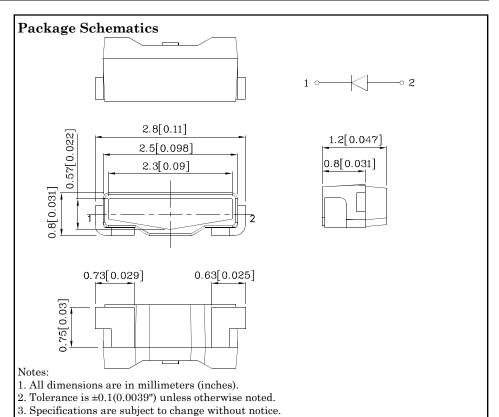






# ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Absolute Maximum Ratings (T <sub>A</sub> =25°C)	FBB (InGaN)	Unit			
Reverse Voltage	$V_{\rm R}$	5	V		
Forward Current	$I_{\mathrm{F}}$	30	mA		
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	100	mA		
Power Dissipation	$P_{D}$	120	mW		
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C		
Storage Temperature	Tstg	-40 ~ +85			

Operating Characteristics (T <sub>A</sub> =25°C)		FBB (InGaN)	Unit
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{ m F}$	3.3	V
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{ m F}$	4	V
Reverse Current (Max.) $(V_R=5V)$	$I_R$	50	uA
Wavelength of Peak Emission (Typ.) $(I_F=20 \text{mA})$	λΡ	465	nm
Wavelength of Dominant Emission (Typ.) $(I_F=20 \text{mA})$	λD	470	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$\triangle \lambda$	22	nm
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	C	100	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous} \\ \text{Intensity} \\ \text{(I_F=20mA)} \\ \text{mcd} \end{array}$		Wavelength $nm \ \lambda P$	Viewing Angle 20 1/2
				min.	typ.		
XZFBB81FS	Blue	InGaN	Water Clear	220	347	465	110°

Feb 14,2011 XDSB5456 V2 Layout: Maggie L.



# **Handling Precautions**

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

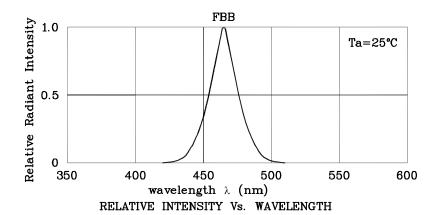


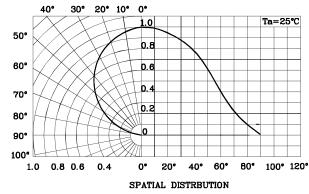
2. As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Feb 14,2011 XDSB5456 V2 Layout: Maggie L.

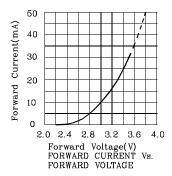


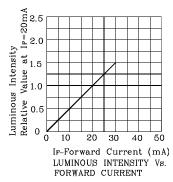


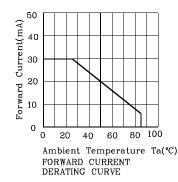


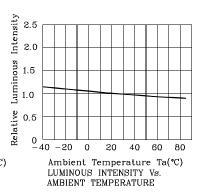


#### **❖** FBB



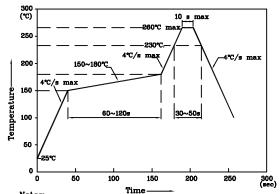






LED is recommended for reflow soldering and soldering profile is shown below.

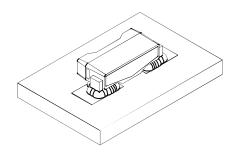
Reflow Soldering Profile for SMD Products (Pb-Free Components)



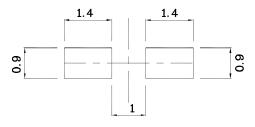
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



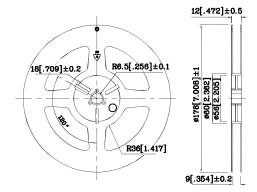
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



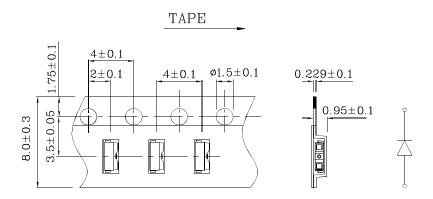
**❖** Recommended Soldering Pattern (Units:mm; Tolerance: ± 0.1)



### **❖** Reel Dimension



# **❖** Tape Specification (Units:mm)



# Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

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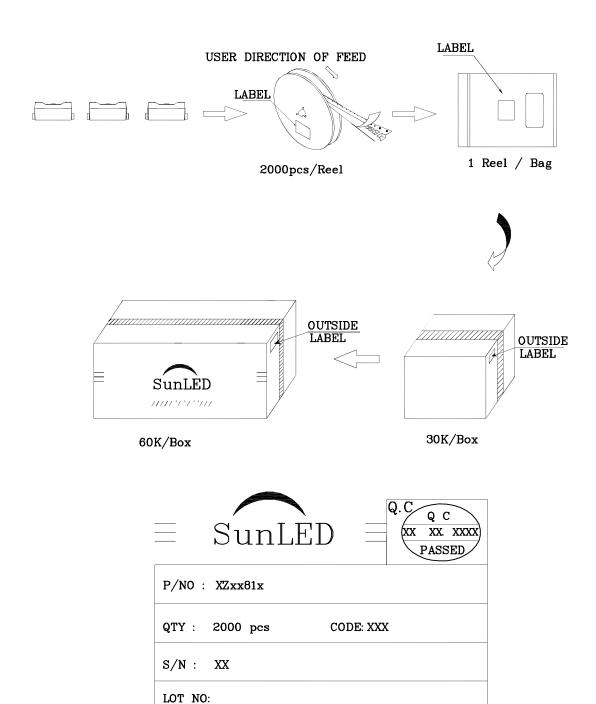
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

XDSB5456 V2 Layout: Maggie L.



### PACKING & LABEL SPECIFICATIONS



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RoHS Compliant